

## Reliability Data Report Product Family R413

LTC987 LTC1726/27/28
LTC1921/85 LTC2369
LTC2900/01/02/03/04/05/06/07/08/09/10
LTC2911/12/13/14/15/16/17/18/19
LTC2920/23/24/25/26/27/28
LTC2930/31/32/50/51/54
LTC4150/4257/4261/4263/4265/4267
LTC4301/4302/4354/4370



## **Reliability Data Report** Report Number: R413 Report generated on: Thu Sep 20 10:01:49 PDT 2012

OPERATING L	IFE TEST	T	<b>I</b>		
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE HRS	No. of FAILURES
		CODE	CODE	(+125°C) <sup>1</sup>	2,3
QFN/DFN	388	0421	0839	323	0
SSOP/TSSOP	1127	0213	0721	947	0
SOIC/SOT/MSOP	2020	9914	0731	1778	0
Totals	3,535	-	-	3,048	0
PRESSURE CO	OKER TEST A	T 15 PSIG , +12	1 DEG C		
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE HRS	No. of FAILURES
		CODE	CODE		
QFN/DFN	4783	0325	1122	478	0
SSOP/TSSOP	5047	0436	1124	251	0
SOIC/SOT/MSOP	11500	9924	1122	729	0
Totals	21,330	-	-	1,458	0
TEMP CYCLE	FROM -65 TO 1	50 DEG C			
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE	No. of FAILURE
	O O	CODE	CODE	CYCLES	
QFN/DFN	4280	0325	1122	1204	0
SSOP/TSSOP	1503	0436	1119	540	0
SOIC/SOT/MSOP	12426	9924	1122	1894	0
Totals	18,209	-	-	3,638	0
THERMAL SHO	OCK FROM -65	TO 150 DEG C			
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE	No. of FAILURES
		CODE	CODE	CYCLES	
QFN/DFN	4243	0325	1122	1193	0
SSOP/TSSOP	1744	0734	1119	450	0
SOIC/SOT/MSOP	8918	9924	1122	1524	0
Totals	14,905	-	-	3,167	0
HIGH TEMPER	ATURE BAKE	AT 150 DEG C			
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE HRS	No. of FAILURES
	J 22 V.22	CODE	CODE		
QFN/DFN	245	0743	0852	245	0
SSOP/TSSOP	50	1018	1018	25	0
Totals	295	-	- 1010	270	0
างเสเจ	233			210	

(1) Assumes Activation Energy = 0.7 Electron Volts
(2) Failure Rate Equivalent to +55 °C, 60% Confidence Level =0.6 FITS
(3) Mean Time Between Failure in Years = 189802.31
Note 1: 1 FIT = 1 Failure in One Billion Hours.
Note 2: HAST, Temp Cycle & Thermal Shock are subjected to J-STD-020 MSL Preconditioning



## Reliability Data Report Report Number: R413 Report generated on: Thu Sep 20 10:01:49 PDT 2012

HIGH TEMPERATURE BAKE AT 175 DEG C									
PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE	NEWEST DATE	K DEVICE HRS	No. of FAILURES				
SSOP/TSSOP	50	1018	1018	25	0				
SOIC/SOT/MSOP	150	0838	0906	125	0				
Totals	200	-	-	150	0				